		•						
United States of America Combined Declaration and Power of Attorney for Patent Application						FILE NO. 04146-UPL		
As a below named inventor, I here verily believe that I am the original, fill isted below) of the subject matter which	eby declare that my resident irst and sole inventor (if only	nce, post offi y one name	ice address ar	nd citizensh w) or an or	hip are as stated i	below next to	my name and that	
BONDING STRUCTURE specification of which is attached heret		AYER A	AND ME	rhod (OF FORMI	NG THE	SAME_, the	
I hereby state that I have reviewe amendment referred to above.		itents of the	: above identif	ied specifi	cation, including	the claims, as	s amended by any	
I acknowledge the duty to disclos Section 1.56.	e all information known to t	be material	to patentability	y in accord	fance with Title 3	7, Code of Fε	ederal Regulations,	
I hereby claim priority benefits un United States provisional application(s filing date before that of the application	s) listed below and have als	so identified						
Prior Foreign Application or Provisional	I Application(s)							
Country	APPLICATION NUMBE	ER	Date of Filing (day, month, year				Y CLAIMED 5 U.S.C. 119	
Taiwan	092132948		Nov.	24. 2	2003	YES_X_	_ No	
						YES	No	
I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.								
United States Application Date of Fili Number					(patente	STATUS nted, pending, abandoned)		

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I hereby appoint Jason Z. Lin, Registration No. 37,492, whose address is listed below, as my principal agent with full power of substitution and revocation to prosecute this application, to transact all business in the Patent and Trademark Office connected therewith and to receive all correspondence.								
Send Correspondence To: Supreme Patent Services Post Office Box 2339 Fax: (408) 867-9757 Saratoga, CA 95070-0339 Fax: (408) 867-7437								
I hereby declare that all stateme believed to be true; and further that the by fine or imprisonment, or both, unde validity of the application or any patent	ese statements were made er Section 1001 of Title 18 o	with the kno	owledge that v	willful false	statements and	the like so ma	ade are punishable	
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United States of A	FILE No.						
COMBINED DECLARATION AND POWER OF ATT	04146-UPL						
ADDITIONAL INVENTOR(S) SUPPLEMENTAL SHEET							
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FULL NAME OF ADDITIONAL JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE		DATE				
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Post Office Address		<u> </u>					
FULL NAME OF ADDITIONAL JOINT INVENTOR (if any)	INVENTOR'S SIGNATURE		DATE				
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FULL NAME OF ADDITIONAL JOINT INVENTOR (if any)	Inventor's Signature		DATE				
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